

1 Products affected

Product hierarchy no. *			archy no. *	Part no.	SBU	Type / Description	Customer part no.
SBU	PG	PUG	Туре				
01	002	030	0000000522	0031.8263			n/a
				0031.8264			n/a
				0031.8265	Circuit protection	OCN SMD	n/a
				0031.8273	Circuit protection	OGN-SMD	n/a
				0031.8274			n/a
				0031.8275			n/a

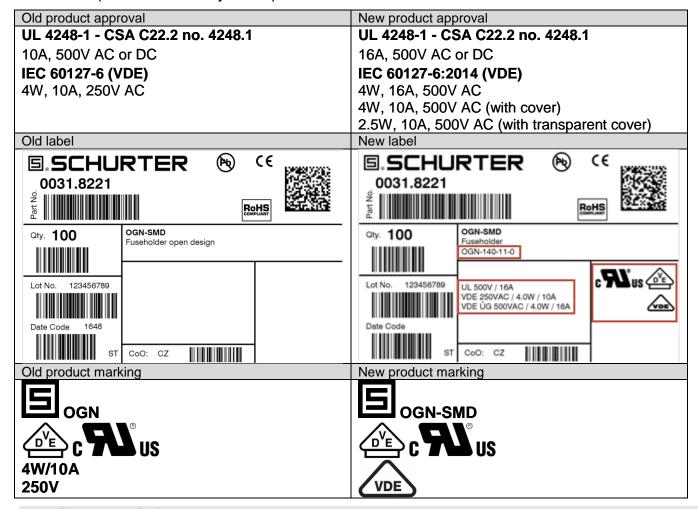
^{*}SBU (2-digit) / PG (3-digit) / PUG (3-digit) / Type (10-digit)

2 Type of change

- Change of material
- Modified label
- Improved electrical ratings
- Change of marking

3 Detailed description of change

The new material fulfil the glow wire requirements given in IEC60127-6:2014 and is free of halogenated flame retardant and red phosphorus. The new material achieves reflow solderability acc. JEDEC JSTD020E (Moisture sensitivity level 1)



4 Reason of change

Product improvement to fulfil the enhanced glow wire requirements according to the updated standard IEC 60127-6:2014.

Product Change Notification						Isolation material change OGN-SMD		
owner	creation date	release date	released by	change order no	rev	page	D40 040 570	
dislercy	2016-11-04	2017-01-31	nowakfr	2011797	Α	1 of 2	D10-010-570	



5 Release date

The change will be rolled-out starting ww 23/2017 and lasts approx. 6 months.

6 Impact of change and recommended action

Form Yes Inscription on socket and isolation material changed

Fit No No change for dimension

Function Yes Moisture sensitivity level 1 acc. JEDEC J-STD020E

Rating enhancement acc. to IEC and UL

Manufacturing No No change for manufacturing site

Label Yes Approvals and configuration code on label

Packaging No No change in packaging

7 Reference Documents / Attachments

Kind of document	Remarks
Data Sheet	

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